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SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORPORATION

(Incorporated in the Cayman Islands with limited liability) (STOCK CODE: 00981)

SMIC REPORTS UNAUDITED RESULTS FOR THE THREE MONTHS ENDED SEPTEMBER 30, 2020

The consolidated financial information is prepared in accordance with International Financial below.

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Fourth Quarter 2020 Guidance

The following statements are forward looking statements based on current expectations and involved Forward-Looking The Company expects:

- Revenue to decrease by 10% to 12% QoQ.
 - Gross margin to range from 16% to 18%.

Dr. Gao Yonggan :

C to reach a record high of US\$1,083 million, up 15.3% quarter-over-quarter and 32.6% year-over-year. The Company achieved historical highs for gross profit of \$262 million, profit for the period attributable to SMIC of \$256 million, and EBITDA of \$653 million. The expected annual revenue growth is revised to increase 24%-26%, and the annual gross margin is targeted to be higher than last year."

Dr. Zhao Haiju -Chief Executive Officers commented:

Demand for non-FinFET technology application platforms continues to be strong, with significant growth from applications such as power management, RF signal processor, fingerprint sensor, and image signal processor. Our FinFET technology addresses a diverse range of applications, and the yield of our first-generation FinFET technology has achieved industry standards, while our second-generation FinFET technology is entering small-volume risk production. The C expanding steadily; at the same time, our utilization rate maintains at a high level.

The macro-

Conference Call / Webcast Announcement

Date: November 12, 2020 Time: 8:30 a.m. Beijing time

Dial-in:

Teleconference call services are affected by the COVID-19, operator assisted conference calls are not available at the moment. You must preregister online in order to receive the dial-in numbers.

Online registration:

You may register for the conference call at: http://apac.directeventreg.com/registration/event/7678378

Once preregistration has been complete, you will receive dial-in numbers, the passcode, and a unique registrant ID. To join the conference, dial the number you receive in the email, enter the passcode followed by your registrant ID, and you will join the conference instantly.

The call will be webcast live with audio at:

http://www.smics.com/en/site/company_financialSummary or https://edge.media-server.com/mmc/p/js48isvc

An archived version of the webcast, along with an electronic copy of this news release will be available on the SMIC website for a period of 12 months following the webcast.

About SMIC

Semiconductor Manufacturing International Corporation (SSE STAR MARKET: 688981; SEHK: 00981; OTCQX: SMICY) and its subsidiaries collectively constitute one of the leading

coverage, and most comprehensive in semiconductor manufacturing services. SMIC Group provides integrated circuit (IC) foundry and technology services on process nodes from 0.35 micron to 14 nanometer. Headquartered in Shanghai, China, SMIC Group has an international manufacturing and service base. In China, SMIC has a 300mm wafer fabrication facility (fab), a 200mm fab and a effectively controlled joint-venture 300mm fab for advanced nodes in Shanghai; a 300mm fab and a majority-owned 300mm fab in Beijing; 200mm fabs in Tianjin and Shenzhen; and a majority-owned joint-venture 300mm bumping facility in Jiangyin. SMIC Group also has marketing and customer service offices in the U.S., Europe, Japan, and Taiwan China, and a representative office in Hong Kong China.

For more information, please visit www.smics.com.

Forward-Looking Statements

This release contains, in addition to historical information, forward-looking statements. These forward-looking statements, Quarterly Guidance e statements contained in the quotes of our Co-Chief Executive Officers and Chief Financial Officer are based on SMIC's current assumptions, expectations, beliefs, plans, objectives, and projections about future events or performance. SMIC uses words like "believe," "anticipate," "intend," "estimate," "expect," "project," "target, "going forward", "continue", "ought to", "may", "seek", "should", "plan", "could", "vision", "goals", "aim", "aspire", "objective", "schedules", "outlook" and similar expressions to identify forward looking statements, although not all forward-looking statements contain these words. These forward-looking statements are necessary estimates reflecting judgment of SMIC's senior management and involve significant risks, both known and unknown, uncertainties and other factors that may cause SMIC's actual performance, financial condition or results of operations to be materially different from those suggested by the forward-looking statements including, among others, risks associated with cyclicality and market conditions in the semiconductor industry, intense competition in

the semiconductor industry, SMIC's reliance on a small number of customers, timely wafer acceptance by SMIC's customers, timely introduction of new technologies, SMIC's ability to ramp new products into volume, supply and demand for semiconductor foundry services, industry overcapacity, shortages in equipment, components and raw materials, availability of manufacturing capacity, financial stability in end markets, orders or judgments from pending litigation, intensive intellectual property litigation in the semiconductor industry, general economic conditions and fluctuations in currency exchange rates.

In addition to the information contained in this release, you should also consider the information contained in our other filings with The Stock Exchange of Hong Kong Limited ("SEHK") and Shanghai Stock Exchange (SSE) from time to time. Other unknown or unpredictable factors also could have material adverse effects on our future results, performance or achievements. In light of these risks, uncertainties, assumptions and factors, the forward-looking events discussed in this release may not occur. You are cautioned not to place undue reliance on these forward-looking statements, which speak only as of the date stated or, if no date is stated, as of the date of this release. Except as required by applicable laws, SMIC undertakes no obligation and does not intend to update any forward-looking statement to reflect events or circumstances after the date on which such statement is made or to reflect the occurrence of unanticipated events, whether as a result of new information, future events or otherwise.

About Non-International Financial Reporting Standards non-IFRS) Financial Measures

in this release non-IFRS measures of operating results that are adjusted to exclude finance cost, depreciation and amortization, income tax benefits and expenses, the effect of employee bonus accrual, government funding, impairment loss of tangible and intangible assets, gain or loss on the disposal of machinery and equipment and gain from the disposal of living quarters. The presentation of non-IFRS financial measures is not intended to be considered in isolation or as a substitute for the financial information prepared and presented in accordance with IFRS. This earnings release includes EBITDA, EBITDA margin and non-IFRS operating expenses which consist of total operating expenses as adjusted to exclude the effect of employee bonus accrual, government funding, impairment loss of tangible and intangible assets, gain or loss on the disposal of machinery and equipment and gain from the disposal of living quarters. These non-IFRS financial measures are not calculated or presented in accordance with, and are not alternatives or substitutes for financial measures prepared in accordance with IFRS, and should be read only in conjunction with the Group's financial measures prepared in accordance with IFRS. The Group's non-IFRS financial measures may be different from similarly-titled non-IFRS financial measures used by other companies.

SMIC believes that use of these non-IFRS financial measures faci

non-

IFRS financial measures to understand, manage and evaluate the Group's business and make financial and operational decisions.

The accompanying table has more information and reconciliations of each non-IFRS financial measure to its most directly comparable IFRS financial measure.

Summary of Third Quarter 2020 Operating Results

Amounts in US\$ thousands, except for EPS and operating data

	3Q20	2Q20	QoQ	3Q19	YoY
Revenue	1,082,505	938,463	15.3%	816,452	32.6%
Cost of sales	(820,528)	(689,874)	18.9%	(646,637)	26.9%
Gross profit	261,977	248,589	5.4%	169,815	54.3%
Operating expenses	(79,287)	(183,923)	-56.9%	(122,665)	-35.4%
Profit from operations	182,690	64,666	182.5%	47,150	287.5%
Other income, net	101,793	76,999	32.2%	41,537	145.1%
Profit before tax	284,483	141,665	100.8%	88,687	220.8%
Income tax expense	(20,959)	(16,029)	30.8%	(4,061)	416.1%
Profit for the period	263,524	125,636	109.8%	84,626	211.4%
Other comprehensive income (loss): Exchange differences on translating foreign operations Cash flow hedges	29,953 2,693	(4,941) (14,577)	-	(20,032) (10,617)	-
Total comprehensive income	296,170	106,118	179.1%	53,977	448.7%
for the period	200,110	100,110		33,311	
Profit (loss) for the period attributable to:					
Owners of the Company	256,379	137,969	85.8%	115,135	122.7%
Non-controlling interests	7,145	(12,333)	-	(30,509)	-

Profit for the p864 43ETQq66.864 432.29

- Revenue was \$1,082.5 million in 3Q20, an increase of 15.3% QoQ from \$938.5 million in 2Q20.
 Revenue increased in 3Q20 mainly due to the strong demand, the increase in average selling price and increase in other revenue in 3Q20.
- Cost of sales was \$820.5 million in 3Q20, compared to \$689.9 million in 2Q20. Cost of sales increased in 3Q20 mainly due to the additional manufacturing costs associated with the commencement of mass production of the effectively controlled Shanghai 300mm fab since June 2020.
- Gross profit was \$262.0 million in 3Q20, an increase of 5.4% QoQ from \$248.6 million in 2Q20.
 Gross profit increased in 3Q20 due to the net effects above mentioned in Revenue and Cost of sales.
- Gross margin was 24.2% in 3Q20, compared to 26.5% in 2Q20.
- Operating expenses were \$79.3 million in 3Q20, a decrease of 56.9% QoQ from \$183.9 million in 2Q20, mainly due to the reasons stated in <u>Operating Expenses (Income)</u> below.
- Other income (expense), net was \$101.8 million gain in 3Q20, as compared to \$77.0 million gain in 2Q20. The change was mainly due to the reasons stated in Other Income (Expense), Net below.

Analysis of Revenue

Revenue Analysis						
By Geography	3Q20	2Q20	3Q19			
North America ⁽¹⁾	18.6%	21.6%	24.7%			
Mainland China and Hong Kong	69.7%	66.1%	60.5%			
Eurasia ⁽²⁾	11.7%	12.3%	14.8%			
By Service Type	3Q20	2Q20	3Q19			
Wafers	85.4%	90.9%	92.5%			
Others	14.6%	9.1%	7.5%			
Wafer Revenue Analysis						
By Application	3Q20	2Q20	3Q19			
Smart Phone	46.1%	46.7%	42.3%			
Smart Home	20.5%	16.4%	17.0%			
Consumer Electronics	17.0%	17.2%	22.2%			
Others	16.4%	19.7%	18.5%			
By Technology	3Q20	2Q20	3Q19			
14/28 nm	14.6%	9.1%	4.3%			
40/45 nm	17.2%	15.4%	18.5%			
55/65 nm	25.8%	30.0%	29.3%			
90 nm	3.4%	2.8%	1.3%			
0.11/0.13 μm	4.4%	5.4%	6.6%			
0.15/0.18 μm	31.2%	33.0%	35.8%			
0.25/0.35 μm	3.4%	4.3%	4.2%			

Note:
(1) Presenting the revenue to those companies whose headquarters are in the United States, but ultimately selling and shipping the products to their global customers.
(2) Excluding Mainland China and Hong Kong.

Capacity

 Monthly capacity was 510,150 8-inch equivalent wafers in 3Q20 from 480,150 8-inch equivalent wafers in 2Q20, primarily due to the capacity expansion in the Beijing 300mm fab and the majorityowned Beijing 300mm fab in 3Q20.

Shipment and Utilization

	3Q20	2Q20	QoQ	3Q19	YoY
Wafer shipments	1,440,531	1,435,591	0.3%	1,315,443	9.5%
Utilization rate ⁽¹⁾	97.8%	98.6%	-	97.0%	-

Note:

Detailed Financial Analysis

Gross Profit

Amounts in US\$ thousands	3Q20	2Q20	QoQ	3Q19	YoY
Cost of sales	820,528	689,874	18.9%	646,637	26.9%
Depreciation and amortization	249,415	210,976	18.2%	201,476	23.8%
Other manufacturing costs	571,113	478,898	19.3%	445,161	28.3%
Gross profit	261,977	248,589	5.4%	169,815	54.3%
Gross margin	24.2%	26.5%	-	20.8%	-

Cost of sales was \$820.5 million in 3Q20, compared to \$689.9 million in 2Q20. Cost of sales increased in 3Q20 mainly due to the additional manufacturing costs associated with the commencement of mass production of the effectively controlled Shanghai 300mm fab since June 2020.

⁽¹⁾ Based on total equivalent wafers out divided by estimated total quarterly capacity.

Operating Expenses (Income)

Amounts in US\$ thousands	3Q20	2Q20	QoQ	3Q19	YoY
Operating expenses	79,287	183,923	-56.9%	122,665	-35.4%
Research and development	158,520	157,999	0.3%	185,019	-14.3%
General and administrative	56,970	59,381	-4.1%	70,041	-18.7%
Selling and marketing	6,472	5,072	27.6%	5,900	9.7%
Net impairment losses	(1,835)	1,924	-	1,752	-
(reversal) recognized on financial assets					
Other operating income	(140,840)	(40,453)	248.2%	(140,047)	0.6%

- Research and development increased to \$158.5 million in 3Q20, compared to \$158.0 million in 2Q20.
- General and administrative expenses decreased by 4.1% to \$57.0 million in 3Q20, compared to \$59.4 million in 2Q20. The change was mainly due to the commencement of mass production in our effectively controlled fab in Shanghai in June 2020 and as a result, the pre-operating related expenses decreased.
- The change in other operating income was mainly due to other operating income recognized in relation to government funding of \$137.8 million in 3Q20, compared to \$40.5 million in 2Q20.

Other Income (Expense), Net

Other meetine (Expense), Net					
Amounts in US\$ thousands	3Q20	2Q20	QoQ	3Q19	YoY
Other income, net	101,793	76,999	32.2%	41,537	145.1%
Interest income	48,842	36,069	35.4%	36,810	32.7%
Finance costs	(17,590)	(18,220)	-3.5%	(15,187)	15.8%
Foreign exchange gains (losses)	60,012	1,890	3,075.2%	(248)	-
Other (losses) gains, net	(17,099)	27,789	-	594	-
Share of gain of investment	27,628	29,471	-6.3%	19,568	41.2%
accounted for using equity method					

- Foreign exchange gains were mainly due to the net impact of cash flow hedging and the appreciation of RMB against USD in 3Q20. Foreign monetary assets mainly consist of cash and cash equivalent and trade and other receivables in RMB. Foreign monetary liabilities mainly consist of borrowings, medium-term notes and trade and other payables in RMB.
- The decrease in other (losses) gains, net in 3Q20 was mainly caused by the loss of the fair value change of the investments in equity securities recognized as financial assets at fair value through profit or loss.
- The change in share of gain of investment accounted for using equity method was due to the gain on the investments in associates in 3Q20. Certain associates of the Group are investment funds with a number of investment portfolios. The change in share of gain of investment accounted for using equity method was a result of the fair value change of the portfolios and the increase in the operating income of certain associates in 3Q20.

Depreciation and Amortization

Amounts in US\$ thousands	3Q20	2Q20	QoQ	3Q19	YoY
Depreciation and amortization	351,077	305,734	14.8%	279,622	25.6%

Liquidity		
Amounts in US\$ thousands	3Q20	2Q20

Capital Structure

Amounts in US\$ thousands	3Q20	2Q20
Cash and cash equivalent	8,619,395	3,130,068
Restricted cash - Current	438,583	595,064
Financial assets at fair value through profit or loss - Current ⁽¹⁾	343,521	-
Financial assets at amortized cost - Current ⁽²⁾	2,938,086	3,272,024
Total cash on hand	12,339,585	6,997,156
Borrowings - Current	1,082,866	1,053,686
Borrowings - Non-current	2,084,253	1,690,928
Lease liabilities	268,791	292,268
Short-term notes	-	211,840
Medium-term notes	219,567	211,313
Convertible bonds	15,403	65,000
Bonds payable	596,795	596,625
Total debt	4,267,675	4,121,660

- SMIC's Announcement on Listing Shares in Initial Public Offering on Science and Technology Innovation Board (2020-7-15)
- Inside Information Completion of RMB Share Issue (2020-7-15)
- Notification of Board Meeting (2020-7-13)
- SMIC's Prospectus on Initial Public Offering of Shares and Listing on the Science and Technology Innovation Board (2020-7-13)
- SMIC's Announcement on Issuance Result of Initial Public Offering of Shares and Listing on Science and Technology Innovation Board (2020-7-13)
- SMIC's Announcement on Preliminary Offline Allotment Result and Online Lot-winning Result of Initial Public Offering of Shares and Listing on Science and Technology Innovation Board (2020-7-9)
- SMIC's Announcement on Subscription and Lot-winning Rate of Online Issuance for Initial Public Offering of Shares and Listing on Science and Technology Innovation Board (2020-7-8)
- SMIC's Special Announcement on Investment Risks in Initial Public Offering of Shares and Listing on Science and Technology Innovation Board (2020-7-6)
- SMIC's Announcement on Issuance for Initial Public Offering of Shares and Listing on Science and Technology Innovation Board (2020-7-6)
- Inside Information Determination of Offer Size and Offer Price for Proposed RMB Share Issue under Specific Mandate and Progress of Subscriptions by Connected Persons as Strategic Investors under Proposed RMB Share Issue (2020-7-6)
- SMIC's Announcement on Online Road Show for Initial Public Offering of Shares and Listing on Science and Technology Innovation Board (2020-7-3)

<u>http://www.smics.com/en/site/news</u> and <u>http://www.smics.com/en/site/comapny</u> <u>statutoryDocuments</u> for further details regarding the recent announcements.

Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF PROFIT OR LOSS AND OTHER COMPREHENSIVE INCOME (In US\$ thousands except share data)

For the three months ended

September 30, 2020 June 30, 2020
(Unaudited)

Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF PROFIT OR LOSS AND OTHER COMPREHENSIVE INCOME (In US\$ thousands except share data)

Note:

(1) Non-IFRS operating expenses are defined as operating expenses adjusted to exclude the effect of items listed in the following table. SMIC reviews non-IFRS operating expenses together with operating expenses to understand, manage and evaluate its business and make financial and operational decisions. The Group also believes it is useful supplemental information for investors and analysts to assess its operating performance. However, the use of non-IFRS financial measures has material limitations as an analytical tool. One of the limitations of using non-IFRS financial measures is that they do not include all items that impact our net profit for the period. In addition, because non-IFRS financial measures are not calculated in the same manner by all companies, they may not be comparable to other similarly titled measures used by other companies. In light of the foregoing limitations, you should not consider the non-IFRS operating expenses in isolation from or as an alternative to operating expenses prepared in accordance with IFRS.

The following table sets forth the reconciliation of the non-IFRS operating expenses to its most directly comparable financial measure presented in accordance with IFRS, for the periods indicated.

For the three months ended

	September 30, 2020 (Unaudited)	June 30, 2020 (Unaudited)	September 30, 2019 (Unaudited)
Operating expenses	(79,287)	(183,923)	(122,665)
Employee bonus accrued	4,943	9,365	6,125
Government funding	(137,751)	(40,458)	(58,309)
Gain on the disposal of subsidiaries	(904)	<u>-</u>	(81,377)
(Gain) loss of the disposal of machinery and equipment	(2,293)	110	242
Loss (gain) of the disposal of living quarters	107	(105)	(603)
Non-IFRS operating expenses	(215,185)	(215,011)	(256,587)

Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF PROFIT OR LOSS AND OTHER COMPREHENSIVE INCOME (In US\$ thousands except share data)

(2) EBITDA is defined as profit for the period excluding the impact of the finance cost, depreciation and amortization, and income tax benefit and expense. EBITDA margin is defined as EBITDA divided by revenue. SMIC uses EBITDA margin as a measure of operating performance; for planning purposes, including the preparation of the

measure finance cost, income tax benefit and expense and depreciation and amortization that can vary substantially from company to company depending upon their respective financing structures and accounting policies, the book values of their assets, their capital structures and the methods by which their assets were acquired, EBITDA has limitations as an analytical tool, and you should not consider it in isolation or as a substitute for analysis

requirements for capital expenditures or other contractual commitments; it does not reflect changes in, or cash finance cost; it does not reflect cash

requirements for income taxes; that, although depreciation and amortization are non-cash charges, the assets being depreciated or amortized will often have to be replaced in the future, and these measures do not reflect any

measures differently than SMIC does, limiting their usefulness as comparative measures.

The following table sets forth the reconciliation of EBITDA and EBITDA margin to their most directly comparable financial measures presented in accordance with IFRS, for the periods indicated.

	For the three months ended				
	September 30, 2020 (Unaudited)	June 30, 2020 (Unaudited)	September 30, 2019 (Unaudited)		
Profit for the period	263,524	125,636	84,626		
Finance costs	17,590	18,220	15,187		
Depreciation and amortization	351,077	305,734	279,622		
Income tax expense	20,959	16,029	4,061		
EBITDA					

Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF FINANCIAL POSITION (In US\$ thousands)

	As of	
	September 30, 2020	June 30, 2020
	(Unaudited)	(Unaudited)
ASSETS		
Non-current assets		
Property, plant and equipment	11,293,702	9,340,611
Right-of-use assets	401,308	425,701
Intangible assets	89,785	88,763
Investments in associates	1,209,846	1,132,823
Investments in joint ventures	27,707	57,886
Deferred tax assets	25,172	26,994
Financial assets at fair value through profit or loss	120,274	129,399
Financial assets at amortized cost	1,557,799	-
Derivative financial instruments		

Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENTS OF FINANCIAL POSITION (In US\$ thousands)

	As of	
	September 30, 2020	June 30, 2020
	(Unaudited)	(Unaudited)
EQUITY AND LIABILITIES		
Capital and reserves		
Ordinary shares		
\$0.004 par value, 10,000,000,000 shares authorized, 5,759,999,472 and 5,690,665,932 shares outstanding at September 30, 2020 and June 30, 2020, respectively	30,794	22,763
Share premium	13,505,503	5,898,540
Reserves	29,404	1,879
Retained earnings	1,004,018	747,639
Equity attributable to owners of the Company	14,569,719	6,670,821
Perpetual subordinated convertible securities	299,388	339,307
Non-controlling interests	6,168,467	6,167,547
Total equity	21,037,574	13,177,675
Non-current liabilities		
Borrowings	2,084,253	1,690,928
Lease liabilities	174,057	197,850
Bonds payable	596,795	596,625
Medium-term notes	219,567	211,313
Deferred government funding	531,000	591,384
Derivative financial instruments	47,559	72,075
Convertible bonds	15,403	-
Other liabilities	-	13,959
Total non-current liabilities	3,668,634	3,374,134
Current liabilities		
Trade and other payables	2,346,625	1,782,387
Contract liabilities	143,963	88,414
Borrowings	1,082,866	1,053,686
Lease liabilities	94,734	94,418
Convertible bonds	-	65,000
Short-term notes	-	211,840
Deferred government funding	291,301	312,441
Accrued liabilities	140,291	154,325
Derivative financial instruments	132,365	26,767
Other financial liabilities	-	11,581
Current tax liabilities	14,276	12,508
Other liabilities	33,650	23,002
Total current liabilities	4,280,071	3,836,369
Total liabilities	7,948,705	7,210,503
TOTAL EQUITY AND LIABILITIES	28,986,279	20,388,178

Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF CASH FLOWS (In US\$ thousands)

For the three months ended September 30, 2020 June 30, 2020

By order of the Board **Semiconductor Manufacturing International Corporation**

Dr. Gao Yonggang
Executive Director, Chief Financial Officer and Company Secretary

Shanghai, November 11, 2020

As at the date of this announcement, the directors of the Company are:

Executive Directors

ZHOU Zixue (Chairman)
ZHAO Haijun (Co-Chief Executive Officer)
LIANG Mong Song (Co-Chief Executive Officer)
GAO Yonggang (Chief Financial Officer and Company Secretary)

Non-executive Directors

CHEN Shanzhi ZHOU Jie REN Kai LU Jun TONG Guohua

Independent Non-executive Directors

William Tudor BROWN CONG Jingsheng Jason LAU Lawrence Juen-Yee FAN Ren Da Anthony YOUNG Kwang Leei